



BC846BLP4

#### 65V NPN SMALL SIGNAL SURFACE MOUNT TRANSISTOR

#### **Features**

- Low Collector-Emitter Saturation Voltage, V<sub>CE(sat)</sub>
- Ultra-Small Leadless Surface Mount Package
- Totally Lead-Free & Fully RoHS Compliant (Note 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

- Case: X2-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.0009 grams (Approximate)

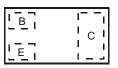
X2-DFN1006-3



Bottom View



Device Symbol



Top View Device Schematic

### Ordering Information (Note 4)

Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
BC846BLP4-7B	3S	7	8	10,000

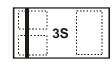
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and</li>

<1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com.

## **Marking Information**



Top View Bar Denotes Base and Emitter Side 3S = Product Type Marking Code



#### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	80	V
Collector-Emitter Voltage	V <sub>CEO</sub>	65	V
Emitter-Base Voltage	V <sub>EBO</sub>	6	V
Collector Current - Continuous	Ic	100	mA
Peak Collector Current	I <sub>CM</sub>	200	mA
Peak Emitter Current	I <sub>EM</sub>	200	mA

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit		
Power Dissinction	(Note 5)	D	0.46	W	
Power Dissipation	(Note 6) PD		1	VV	
Thermal Decistores Junction to Ambient	(Note 5)	P	272	00444	
Thermal Resistance, Junction to Ambient	(Note 6)	R <sub>0JA</sub>	120	°C/W	
Thermal Resistance, Junction to Leads	(Note 7)	R <sub>0JL</sub>	110	°C/W	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

## ESD Ratings (Note 8)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	≥ 8,000	V	3B
Electrostatic Discharge - Machine Model	ESD MM	≥ 400	V	С

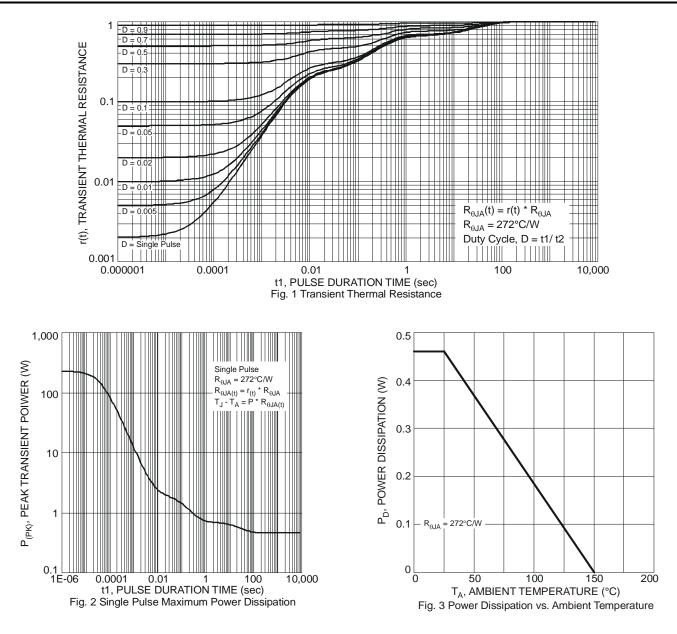
5. For a device surface mounted on minimum recommended pad layout FR-4 PCB with single sided 1oz copper, in still air conditions; the device is Notes: measured when operating in a steady-state condition. The entire exposed collector pad is attached to the heatsink.

6. Same as note 5, except device is surface mounted on 25mm X 25mm collector pad heatsink with 1oz copper.

7. Thermal resistance from junction to solder-point (at the end of the collector lead). 8. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



# **Thermal Characteristics**





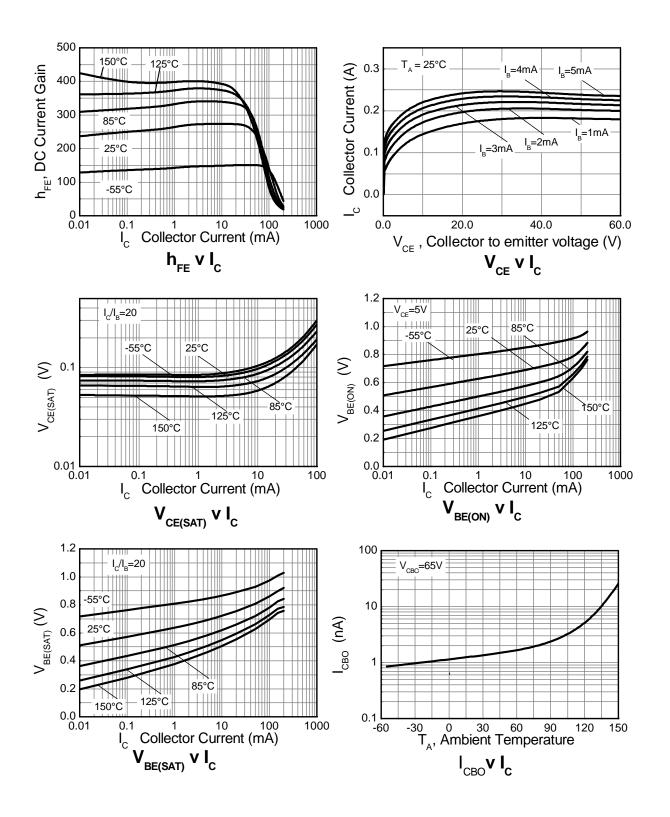
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	80	—	_	V	$I_{\rm C} = 100 \mu A, I_{\rm E} = 0$
Collector-Emitter Breakdown Voltage (Note 9)	BV <sub>CEO</sub>	65	_		V	$I_{\rm C} = 10 {\rm mA}, I_{\rm B} = 0$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	6	_		V	$I_{\rm E} = 100 \mu A, I_{\rm C} = 0$
Collector Cutoff Current	I <sub>CES</sub>	_	—	15	nA	$V_{CE} = 65V$
Collector Cutoff Current	I <sub>CBO</sub>	_	_	15 5.0	nA μA	V <sub>CB</sub> = 40V V <sub>CB</sub> = 30V, T <sub>A</sub> = +150°C
ON CHARACTERISTICS (Note 9)						
DC Current Gain	h <sub>FE</sub>	200	270	450		$V_{CE} = 5V, I_{C} = 2.0mA$
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	_	90 220	250 600	mV	$I_{C} = 10$ mA, $I_{B} = 0.5$ mA $I_{C} = 100$ mA, $I_{B} = 5.0$ mA
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>		720 870	900	mV	$I_{C} = 10$ mA, $I_{B} = 0.5$ mA $I_{C} = 100$ mA, $I_{B} = 5.0$ mA
Base-Emitter Voltage	V <sub>BE(on)</sub>	580 —	650 —	700 770	mV	$V_{CE} = 5V, I_C = 2.0mA$ $V_{CE} = 5V, I_C = 10mA$
SMALL SIGNAL CHARACTERISTICS (Note 9)		-		-		
Input Capacitance	C <sub>ibo</sub>		6.7		pF	$V_{CB} = 5V, f = 1.0MHz$
Output Capacitance	C <sub>obo</sub>		1.76		pF	$V_{CB} = 10V, f = 1.0MHz$
Current Gain-Bandwidth Product	f <sub>T</sub>	100	300		MHz	$V_{CE} = 5V, I_{C} = 10mA, f = 100MHz$
Noise Figure	NF	_	2	10	dB	$V_{CE}$ = 5V, I <sub>C</sub> = 200µA, R <sub>S</sub> = 2.0k $\Omega$ , f = 1.0kHz, $\Delta$ f = 200Hz
Delay time	t <sub>d</sub>		11.2		ns	V 00V
Rise time	tr		59.7		ns	$V_{\rm CC} = 30V,$
Storage time	ts		190.8		ns	$I_{\rm C} = 150 {\rm mA},$
Fall time	t <sub>f</sub>		108.6		ns	$I_{B1} = I_{B2} = 15mA$

Note: 9. Measured under pulsed conditions. Pulse width  $\leq$  300µs. Duty cycle  $\leq$  2%.

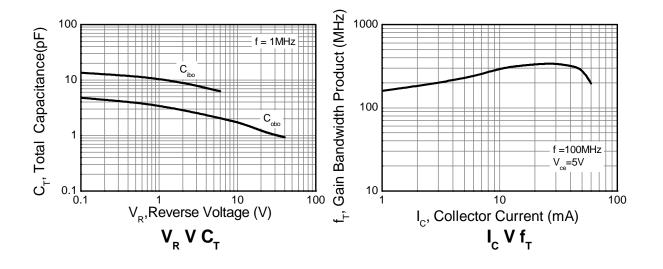


# **Typical Electrical Characteristics**

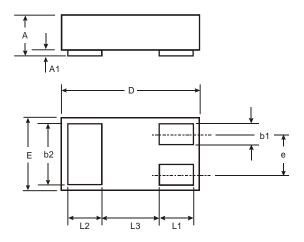




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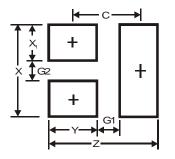


# Package Outline Dimensions



	X2-DFN1006-3					
Dim	Min	Max	Тур			
Α		0.40				
A1	0	0.05	0.03			
b1	0.10	0.20	0.15			
b2	0.45	0.55	0.50			
D	0.95	1.05	1.00			
ш	0.55	0.65	0.60			
е			0.35			
L1	0.20	0.30	0.25			
L2	0.20	0.30	0.25			
L3	_	_	0.40			
All	All Dimensions in mm					

# **Suggested Pad Layout**



Dimensions	Value (in mm)		
Z	1.1		
G1	0.3		
G2	0.2		
Х	0.7		
X1	0.25		
Y	0.4		
С	0.7		



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